

June, 2023



NEWSLETTER

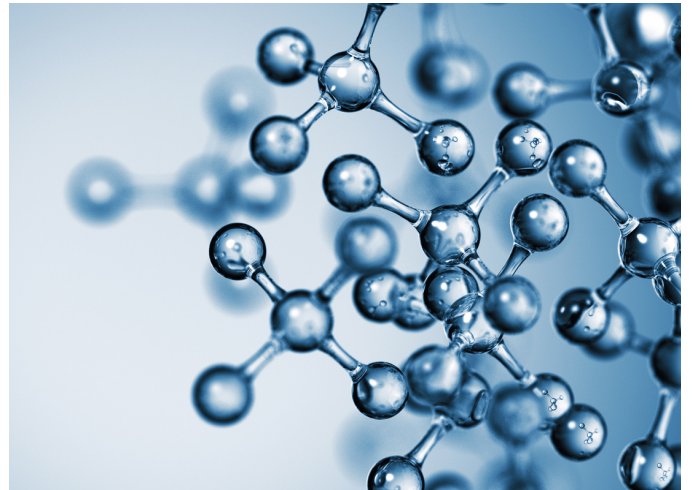
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COMSE 2023

2023 2nd International Conference on Materials Science and Engineering

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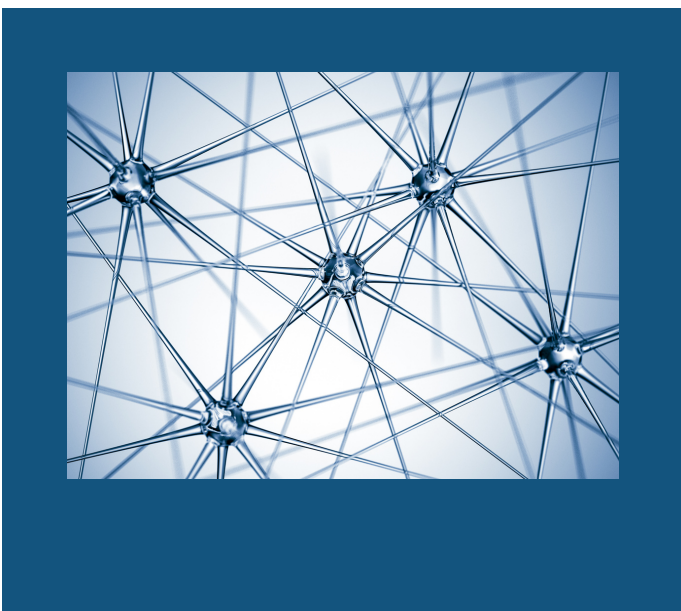
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2023 International Conference on Smart Materials and Surfaces



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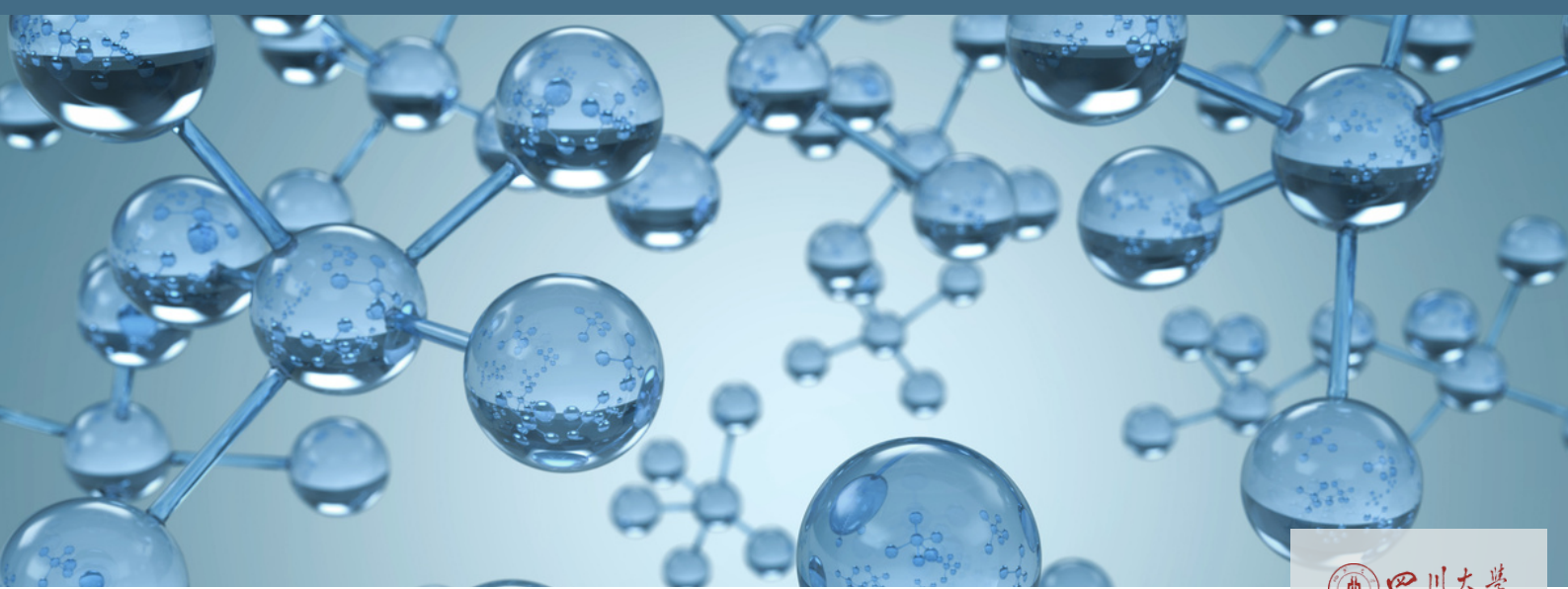
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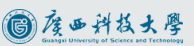
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2023 2nd International Conference on Materials Science and Engineering



Introduction

2023 2nd International Conference on Materials Science and Engineering (CoMSE 2023) will be held in Taizhou, China from July 21-23, 2023. Organized by Sichuan University, State Key Laboratory of Subtropical Building Science of South China University of Technology, and IAEEEE, co-organized by Shanghai Jiao Tong University, Zhejiang University, Southwest Jiaotong University, University of Electronic Science and Technology of China, Xiangtan University, Nano Materials Science, and Jiangsu Foundry Society, the conference offers networking opportunities for scientists, researchers, scholars, engineers, and students to share their innovative research and practical solutions in the field of materials science and engineering. It aims to advance joint collaboration and stimulate groundbreaking ideas.



Conference Chairs



Zidong Wang
University of Science and
Technology Beijing, China



Sheng Han
Shanghai Institute of
Technology, China



Haiyang Zou
Sichuan University, China



Jinbin Wang
Xiangtan University, China



Jiangmiao Yu
South China University of
Technology, China



ICoSMS 2023

Introduction

- July 21-23
- Taizhou, China
- www.icosms.org

2023 International Conference on Smart Materials and Surfaces (ICoSMS 2023) will be held in Taizhou, China during July 21-23, 2023.

The conference is dedicated to providing the platform and opportunities for researchers, scientists, engineers and scholars to exchange and share their experiences, new ideas and research in the common research field of Smart Materials and Surfaces, and to discuss practical issues, the challenges encountered as well as the solutions adopted.

The ICoSMS 2023 conference committee is excited to invite authors and scholars from all over the world to participate in this significant conference, to enhance our knowledge and create new knowledge to help promote the advances and changes of the joint academic researches.

Conference Chairs



Hezhou Liu
Shanghai Jiao Tong
University, China



Wanbiao Hu
Yunnan University, China



Yan Wang
University of Electronic
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of China, China



Ximin He
University of California
Los Angeles, USA

Conference Co-Chairs